

AMENDMENTS TO THE SPECIFICATION:

Please set forth the title of the application to read as follows consistent with the title provided on the application and the executed application documents:

--ONE COMPONENT RESIN COMPOSITION CURABLE WITH COMBINATION OF LIGHT AND HEAT AND USE OF THE SAME--.

Please amend the paragraph at page 12, line 23, as follows:

The acrylic ester monomer and/or methacrylic ester monomer, or an oligomer thereof (2) which can be used in the invention is exemplified by the followings:

diacrylate and/or dimethacrylate of tris(2-hydroxyethyl)isocyanurate; ~~tris(2-hydroxyethyl)isocyanurate triacrylate and/or trimethacrylate~~ triacrylate and/or trimethacrylate of tris(2-hydroxyethyl) isocyanurate; trimethylolpropane triacrylate and/or trimethacrylate, or an oligomer thereof; pentaerythritol triacrylate and/or trimethacrylate, or an oligomer thereof; polyacrylate and/or polymethacrylate of dipentaerythritol; tris(acryloxyethyl)isocyanurate; caprolactone-modified tris(acryloxyethyl)isocyanurate; caprolactone-modified tris(methacryloxyethyl)isocyanurate; polyacrylate and/or polymethacrylate of alkyl-modified dipentaerythritol; polyacrylate and/or polymethacrylate of caprolactone-modified dipentaerythritol; or the like. These may be used alone or in a combination of two or more kinds.

Please amend the paragraph at page 15, line 16, as follows:

(4) Photo radical initiator

The photo radical initiator (4) which can be used in the invention is not particularly limited, and a well-known material can be used. Specific examples thereof include benzoin-based compounds, acetophenones, benzophenones, ~~thioxanones~~ thioxanones, anthraquinones, α -acyloxime esters, phenylglyoxylates, benzils, azo compounds, diphenyl sulfide-based compounds, acylphosphine oxide-based compounds, organic colorant-based compounds, iron-phthalocyanine-based compounds, and the like. These may be used alone or in a combination of two or more kinds.

Please amend the paragraph at page 46, line 13, as follows:

As the above-described ingredient (6), the partially esterified epoxy resin synthesized in the following Synthesis Example 1 was used.

Please amend the paragraph at page 51, line 21, as follows:

The maintenance of the adhesive strength relative to the adhesive strength before the high-temperature and high-humidity storage of more than 50% represents good adhesion reliability after the high-temperature and high-humidity storage, which was indicated by the symbol A in Examples; the maintenance of 30 to 50% represents slightly poor adhesion reliability after the high-temperature and high-humidity storage, which was indicated by the symbol B in Examples; and the maintenance of less than 30% represents poor ~~heat-curability (curability in the light-shielded area)~~ adhesion reliability after the high-temperature and high-humidity storage which was indicated by the symbol C in Examples.

Please amend the paragraph at page 59, line 12, as follows:

(6) Partially esterified epoxy resin

- Synthesis Example 1; partially esterified epoxy resin with methacrylic acid of
Bisphenol F type epoxy resin